



B220AF-B245AF

2.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

B220AF/B230AF/B240AF/B245AF

V _{RRM} (V)	I ₀ (A)	V _F (MAX) (V) @ +25°C	I _{R(MAX)} (mA) @ +25°С
20	2	0.5	0.10
30	2	0.5	0.10
40	2	0.5	0.20
45	2	0.5	0.20

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-Temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (£3)
- Polarity: Cathode Band
- Weight: 0.036 grams (Approximate)

SMAF



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
B220AF-13	SMAF	10,000/Tape & Reel
B230AF-13	SMAF	10,000/Tape & Reel
B240AF-13	SMAF	10,000/Tape & Reel
B245AF-13	SMAF	10,000/Tape & Reel

Notes:

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



B2XXAF = Product Type Marking Code, ex: B220AF JII = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 7 for 2017) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	B220AF	B230AF	B240AF	B245AF	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	20	30	40	45	V
Average Rectified Output Current	lo		2	2		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}		5	0		A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	90	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	45	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

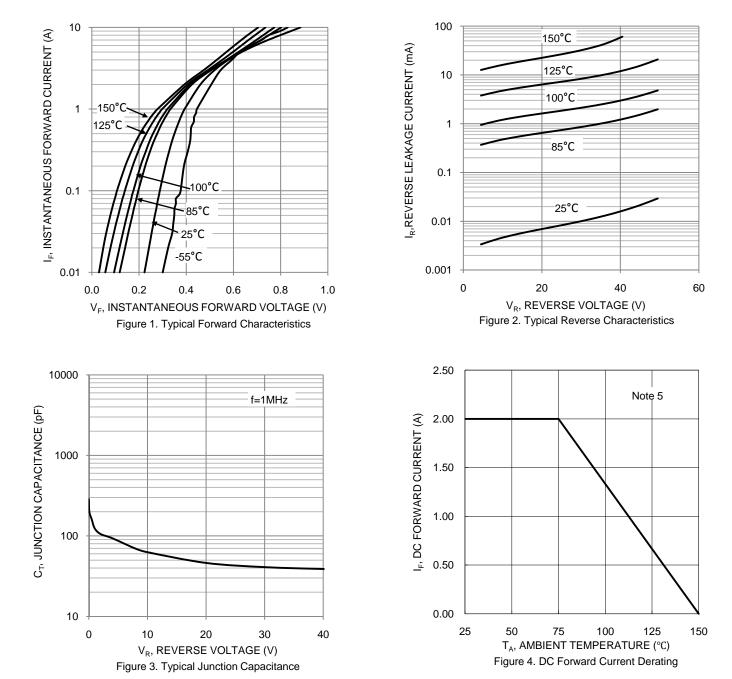
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	0	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop		V _F		0.46 0.42	0.50	V	I _F = 2A, T _J = +25°C I _F = 2A, T _J = +125°C
Leakage Current (Note 6)	B220AF B230AF B240AF B245AF	I _R		0.01 0.015 0.02 0.03 16	0.10 0.10 0.20 0.20 —	mA	$V_{R} = 20V, T_{J} = +25^{\circ}C$ $V_{R} = 30V, T_{J} = +25^{\circ}C$ $V_{R} = 40V, T_{J} = +25^{\circ}C$ $V_{R} = 45V, T_{J} = +25^{\circ}C$ $V_{R} = 45V, T_{J} = +125^{\circ}C$
Typical Capacitance		CT	_	93	_	pF	V _R = 4.0V, f = 1MHz

Notes: 5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad. 6. Short duration pulse test used to minimize self-heating effect.



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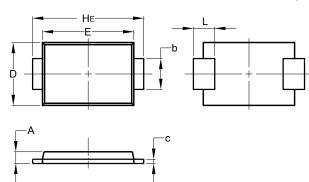


B220AF-B245AF Document number: DS39507 Rev. 2 - 2



Package Outline Dimensions

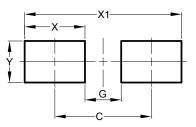
Please see http://www.diodes.com/package-outlines.html for the latest version.



SMAF					
Dim	Min	Max			
Α	0.90	1.10			
b	1.25	1.65			
С	0.10	0.40			
D	2.25	2.95			
E	3.95	4.60			
HE	H _E 4.80 5.60				
L	0.50	1.50			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SMAF	

Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70

SMAF



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